

# RX Family

## RX Family MPC Module Using Firmware Integration Technology Application Note

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### Introduction

This application note describes the Multi-Function Pin Controller (MPC) module which uses Firmware Integration Technology (FIT). This module uses MPC to control the routing of a function to a pin. In this document, this module is referred to as the MPC FIT module.

### Target Devices

- RX110, RX111, RX113 Groups
- RX130 Group
- RX13T Group
- RX140 Group
- RX230 Group
- RX231 Group
- RX23T Group
- RX23W Group
- RX23E-A Group
- RX24T Group
- RX24U Group
- RX64M Group
- RX651, RX65N Groups
- RX66T Group
- RX66N Group
- RX671 Group
- RX71M Group
- RX72T Group
- RX72M Group
- RX72N Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

### Target Compilers

- Renesas Electronics C/C++ Compiler Package for RX Family
- GCC for Renesas RX
- IAR C/C++ Compiler for Renesas RX

For details of the confirmed operation contents of each compiler, refer to "6.1 Confirmed Operation Environment".

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## 1. Overview

### 1.1 MPC FIT Module

The MPC FIT module can be used by being implemented in a project as an API. See section 2.13, Adding the FIT Module to Your Project for details on methods to implement this FIT module into a project.

### 1.2 Overview of the MPC FIT Module

Modern MCUs have continued to add more peripherals while still maintaining relatively low pin counts. When this occurs, each pin will have multiple functions allocated to it. On RX MCUs, the routing of a function to a pin is controlled by the Multi-Function Pin Controller. This driver abstracts this functionality allowing use of the same pin definitions from the `r_gpio_rx` module.

### 1.3 Using the FIT MPC module

#### 1.3.1 Using FIT MPC module in C++ project

For C++ project, add FIT MPC module interface header file within extern "C":

```
Extern "C"
{
    #include "r_smc_entry.h"
    #include "r_mpc_rx_if.h"
}
```

### 1.4 API Overview

Table 1.1 lists the API functions included in this module.

**Table 1.1 API Functions**

| Function                        | Description                                 |
|---------------------------------|---|
| <code>R_MPC_Write()</code>      | Sets the function of a pin.                 |
| <code>R_MPC_Read()</code>       | Reads the function configuration of a pin.  |
| <code>R_MPC_GetVersion()</code> | Returns the current version of this module. |

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## 2. API Information

This FIT module has been confirmed to operate under the following conditions.

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### 2.1 Hardware Requirements

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The MCU used must support the following functions:

- MPC

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### 2.2 Software Requirements

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This driver is dependent upon the following FIT modules:

- Renesas Board Support Package (r\_bsp) v5.20 or higher
- General Purpose Input/Output Driver (r\_gpio\_rx)

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### 2.3 Limitations

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#### 2.3.1 RAM Location Limitations

In FIT, if a value equivalent to NULL is set as the pointer argument of an API function, error might be returned due to parameter check. Therefore, do not pass a NULL equivalent value as pointer argument to an API function.

The NULL value is defined as 0 because of the library function specifications. Therefore, the above phenomenon would occur when the variable or function passed to the API function pointer argument is located at the start address of RAM (address 0x0). In this case, change the section settings or prepare a dummy variable at the top of the RAM so that the variable or function passed to the API function pointer argument is not located at address 0x0.

In the case of the CCRX project (e2 studio V7.5.0), the RAM start address is set as 0x4 to prevent the variable from being located at address 0x0. In the case of the GCC project (e2 studio V7.5.0) and IAR project (EWRX V4.12.1), the start address of RAM is 0x0, so the above measures are necessary.

The default settings of the section may be changed due to the IDE version upgrade. Please check the section settings when using the latest IDE.

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### 2.4 Supported Toolchain

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This driver has been confirmed to work with the toolchain listed in 6.1, Confirmed Operation Environment.

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### 2.5 Interrupt Vector

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None.

---

### 2.6 Header Files

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All API calls and their supporting interface definitions are located in "r\_mpc\_rx\_if.h".

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### 2.7 Integer Types

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This project uses ANSI C99. These types are defined in stdint.h.

## 2.8 Configuration Overview

The configuration option settings of this module are located in `r_mpc_rx_config.h`. The option names and setting values are listed in the table below:

| Configuration options in <code>r_mpc_rx_config.h</code> |  |
|---|--|
| <code>MPC_CFG_PARAM_CHECKING_ENABLE</code> 1            | = 1: Include parameter checking in the build.<br>= 0: Omit parameter checking from the build.<br>= <code>BSP_CFG_PARAM_CHECKING_ENABLE</code> :<br>Use the system default setting.<br>Note: Code size can be reduced by excluding parameter checking from the build. |

## 2.9 Code Size

Typical code sizes associated with this module are listed below.

The ROM (code and constants) and RAM (global data) sizes are determined by the build-time configuration options described in 2.8, Configuration Overview. The table lists reference values when the C compiler's compile options are set to their default values, as described in 2.4, Supported Toolchain. The compile option default values are optimization level: 2, optimization type: for size, and data endianness: little-endian. The code size varies depending on the C compiler version and compile options.

| ROM, RAM and Stack Code Sizes |                     |                         |                            |                         |                            |                         |                            |
|-------------------------------|---------------------|-------------------------|----------------------------|-------------------------|----------------------------|-------------------------|----------------------------|
| Device                        | Category            | Memory Used             |                            |                         |                            |                         |                            |
|                               |                     | Renesas Compiler        |                            | GCC                     |                            | IAR                     |                            |
|                               |                     | With Parameter Checking | Without Parameter Checking | With Parameter Checking | Without Parameter Checking | With Parameter Checking | Without Parameter Checking |
| All devices                   | ROM                 | 125 bytes               | 107 bytes                  | 312 bytes               | 280 bytes                  | 435 bytes               | 403 bytes                  |
|                               | RAM                 | 0 byte                  | 0 byte                     | 0 byte                  | 0 byte                     | 0 bytes                 | 0 bytes                    |
|                               | Maximum stack usage | 20 bytes                | 20 bytes                   | -                       | -                          | 52 bytes                | 52 bytes                   |

## 2.10 Parameters

This section describes the parameter structure used by the API functions in this module. The structure is located in `r_mpc_rx_if.h` as are the prototype declarations of API functions.

### 2.10.1 MPC Pin Configuration

This data structure is used for configuring a pin's function. To find valid settings for *pin\_function*, refer to the Multi-Function Pin Controller (MPC) section of your MCU's hardware manual. Select the Pin Function Control Register for the port that your pin is on. On this page you will find a table with available functions for each pin on the selected port.

```

/* Options for configuring the MPC register of a pin. */
typedef struct
{
    uint8_t pin_function; //Which peripheral function is assigned to this pin
    bool    irq_enable;  //This pin is used as IRQ pin
    bool    analog_enable; //This pin is used as ADC input, DAC output, or for
                          //LVD (CMPA2)
} mpc_config_t;

```

---

## 2.11 Return Values

---

This section describes return values of API functions. This enumeration is located in `r_mpc_rx_if.h` as are the prototype declarations of API functions.

Below are the available return values for the `R_MPC_Write()` function.

```
/* Function return type. */
typedef enum
{
    MPC_SUCCESS = 0,
    MPC_ERR_INVALID_CFG, // The configuration specified cannot be applied to
                        // this pin
} mpc_err_t;
```

---

## 2.12 Callback Function

---

None.

---

## 2.13 Adding the FIT Module to Your Project

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This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) or (3) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (2) or (4) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e<sup>2</sup> studio  
By using the Smart Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project. Refer to “Renesas e<sup>2</sup> studio Smart Configurator User Guide (R20AN0451)” for details.
- (2) Adding the FIT module to your project using the FIT Configurator in e<sup>2</sup> studio  
By using the FIT Configurator in e<sup>2</sup> studio, the FIT module is automatically added to your project. Refer to “Adding Firmware Integration Technology Modules to Projects (R01AN1723)” for details.
- (3) Adding the FIT module to your project using the Smart Configurator in CS+  
By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to “Renesas e<sup>2</sup> studio Smart Configurator User Guide (R20AN0451)” for details.
- (4) Adding the FIT module to your project in CS+  
In CS+, please manually add the FIT module to your project. Refer to “Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)” for details.

## 2.14 “for”, “while” and “do while” statements

In this module, “for”, “while” and “do while” statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with “WAIT\_LOOP” as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with “WAIT\_LOOP”.

The following shows example of description.

while statement example :

```
/* WAIT_LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}
```

for statement example :

```
/* Initialize reference counters to 0. */
/* WAIT_LOOP */
for (i = 0; i < BSP_REG_PROTECT_TOTAL_ITEMS; i++)
{
    g_protect_counters[i] = 0;
}
```

do while statement example :

```
/* Reset completion waiting */
do
{
    reg = phy_read(ether_channel, PHY_REG_CONTROL);
    count++;
} while ((reg & PHY_CONTROL_RESET) && (count < ETHER_CFG_PHY_DELAY_RESET)); /* WAIT_LOOP */
```



### 3. API Functions

#### R\_MPC\_Write

This function sets the function of a pin.

##### Format

```
mpc_err_t    R_MPC_Write (
    gpio_port_pin_t    pin,
    mpc_config_t    * pconfig
)
```

##### Parameters

*gpio\_port\_pin\_t pin*  
Which pin to configure.

*mpc\_config\_t \*pconfig*  
Pointer to structure with pin configuration information. See section 2.10.1, MPC Pin Configuration.

##### Return Values

*[MPC\_SUCCESS]* /\* Successful; pin configured. \*/  
*[MPC\_ERR\_INVALID\_CFG]* /\* Error; invalid configuration input \*/

##### Properties

Prototyped in file "r\_mpc\_rx\_if.h"

##### Description

This function will configure a pin based on the information in the `mpc_config_t` structure. Not all pins support the same functionality. For example, not all pins are able to be configured as analog pins for ADC or DAC use. Also, not all combinations of functionality are capable. For example, a pin cannot be configured as an analog pin and for peripheral use at the same time.

To see what functions are available for a pin, refer to the Multi-Function Pin Controller (MPC) section of your MCU's hardware manual. Select the Pin Function Control Register for the port that your pin is on. On this page you will find a table with available functions for each pin on the selected port.

Which pin is to be configured by this function is defined using the `gpio_port_pin_t` type from the `r_gpio_rx` module.

##### Example

```
mpc_config_t    config;
gpio_port_pin_t    pin;

/* Set PE0 to be used as analog pin for ADC. */
pin = GPIO_PORT_E_PIN_0;

config.analog_enable = true;
config.irq_enable = false;
config.pin_function = 0;

if (MPC_SUCCESS != R_MPC_Write(pin, &config))
{
```

```
    /* Error, pin does not support this configuration. Handle error. */
    ...
}

/* Set P27 to be used as IRQ pin and for SCI operations. */
pin = GPIO_PORT_2_PIN_7;

config.analog_enable = false;
config.irq_enable = true;
config.pin_function = 0xA;

if (MPC_SUCCESS != R_MPC_Write(pin, &config))
{
    /* Error, pin does not support this configuration. Handle error. */
    ...
}
```

**Special Notes:**

None.

---

## R\_MPC\_Read

---

This function reads the function configuration of a pin.

### Format

```
void R_MPC_Read (
    gpio_port_pin_t    pin,
    mpc_config_t       * pconfig
)
```

### Parameters

*gpio\_port\_pin\_t pin*  
Which pin to read configuration information for.

*mpc\_config\_t \*pconfig*  
Pointer to structure where pin configuration information will be stored. See Section 2.10.1, MPC Pin Configuration.

### Return Values

*None.*

### Properties

Prototyped in file "r\_mpc\_rx\_if.h"

### Description

This function will read the configuration information for a pin and store it in a structure supplied by the user.

### Example

```
mpc_config_t config;

/* See if P03 has already been configured as analog pin for DAC use. */
R_MPC_Read(GPIO_PORT_0_PIN_3, &config);

if (config.analog_enable == true)
{
    /* P03 has already been set as analog pin. */
    ...
}
else
{
    /* P03 has not been configured yet. Configure it now. */
    ...
}
```

### Special Notes:

*None.*

---

## R\_MPC\_GetVersion

---

Returns the current version of this API.

### Format

uint32\_t R\_MPC\_GetVersion ( void )

### Parameters

*None.*

### Return Values

*Version of this API.*

### Properties

Prototyped in file "r\_mpc\_rx\_if.h"

### Description

This function will return the version of the currently running API. The version number is encoded where the top 2 bytes are the major version number and the bottom 2 bytes are the minor version number. For example, Version 4.25 would be returned as 0x00040019.

### Example

```
uint32_t cur_version;

/* Get version of running r_mpc_rx API. */
cur_version = R_MPC_GetVersion();

/* Check to make sure version is new enough for this application's use. */
if (MIN_VERSION > cur_version)
{
    /* This r_mpc_rx version is not new enough and does not have XXX feature
       that is needed by this application. Alert user. */
    ...
}
```

### Special Notes:

*None.*

#### 4. Pin Setting

MPC FIT module don't use pin setting.

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## 5. Demo Projects

Demo projects include function main() that utilizes the FIT module and its dependent modules (e.g. r\_bsp). This FIT module includes the following demo projects.

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### 5.1 `mpc_demo_rskrx113`, `mpc_demo_rskrx64m`, `mpc_demo_rskrx71m`, `mpc_demo_rskrx65n`, `mpc_demo_rskrx65n_2m`, `mpc_demo_rskrx113_gcc`, `mpc_demo_rskrx64m_gcc`, `mpc_demo_rskrx71m_gcc`, `mpc_demo_rskrx65n_gcc`, `mpc_demo_rskrx65n_2m_gcc`

---

These are the demo programs for the RX113, RX64M, RX71M, RX65N and RX65N-2MB MPC FIT modules. The programs demonstrate how to use the MPC to configure a port bit as an interrupt input. IRQ2 is chosen as the interrupt for these demos and is used to detect key-presses on SW2. Once the code is compiled and down-loaded to the target board and running, SW2 can be pressed to cause IRQ2 (IRQ9 on the RX65N, IRQ13 on the RX65N-2MB) interrupts to occur. The IRQ2 (IRQ9 on the RX65N, IRQ13 on the RX65N-2MB) interrupt handler in turn toggles the state of LED3.

---

### 5.2 `mpc_demo_rskrx231`, `mpc_demo_rskrx231_gcc`

---

This is the demo program for the RX231 FIT module. The description for this program is the same as for the `mpc_demo_rskrx113` demo except that IRQ4 is used to detect SW2 key-presses.

---

### 5.3 `mpc_demo_rskrx72m`, `mpc_demo_rskrx72m_gcc`

---

This is the demo program for the RX72M FIT module. The description for this program is the same as for the `mpc_demo_rskrx71m` demo except that IRQ12 is used to detect SW2 key-presses.

---

### 5.4 `mpc_demo_rskrx671`, `mpc_demo_rskrx671_gcc`

---

This is the demo program for the RX671 FIT module. The description for this program is the same as for the `mpc_demo_rskrx71m` demo except that IRQ10 is used to detect SW2 key-presses.

---

## 5.5 Adding a Demo to a Workspace

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Demo projects are found in the FITDemos subdirectory of the distribution file for this application note. To add a demo project to a workspace, select *File >> Import >> General >> Existing Projects into Workspace*, then click "Next". From the Import Projects dialog, choose the "Select archive file" radio button. "Browse" to the FITDemos subdirectory, select the desired demo zip file, then click "Finish".

---

## 5.6 Downloading Demo Projects

---

Demo projects are not included in the RX Driver Package. When using the demo project, the FIT module needs to be downloaded. To download the FIT module, right click on this application note and select "Sample Code (download)" from the context menu in the *Smart Browser >> Application Notes* tab.

## 6. Appendices

### 6.1 Confirmed Operation Environment

This section describes confirmed operation environment for the MPC FIT module.

**Table 6.1 Confirmed Operation Environment (Rev.4.10)**

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 2021-07<br>IAR Embedded Workbench for Renesas RX 4.20.3   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 8.3.0.202004<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
|                                    | IAR C/C++ Compiler for Renesas RX version 4.20.3<br>Compiler option: The default settings of the integrated development environment.  |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.4.10  |
| Board used                         | Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxxx)  |

Table 6.2 Confirmed Operation Environment (Rev.4.00)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 2021-07<br>IAR Embedded Workbench for Renesas RX 4.20.1   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 8.3.0.202004<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
|                                    | IAR C/C++ Compiler for Renesas RX version 4.20.1<br>Compiler option: The default settings of the integrated development environment.  |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.4.00  |
| Board used                         | Renesas Starter Kit+ for RX140 (product No.: RTK5RX140xxxxxxxxx)  |

Table 6.3 Confirmed Operation Environment (Rev.3.90)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 2021-07<br>IAR Embedded Workbench for Renesas RX 4.20.1   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 8.3.0.202004<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
|                                    | IAR C/C++ Compiler for Renesas RX version 4.20.1<br>Compiler option: The default settings of the integrated development environment.  |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.3.90  |
| Board used                         | Renesas Starter Kit+ for RX671 (product No.: RTK55671xxxxxxxxx)   |



Table 6.4 Confirmed Operation Environment (Rev.3.80)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 2021-01<br>IAR Embedded Workbench for Renesas RX 4.20.1   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 8.3.0.202004<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-WI,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
|                                    | IAR C/C++ Compiler for Renesas RX version 4.20.1<br>Compiler option: The default settings of the integrated development environment.  |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.3.80  |
| Board used                         | Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx)  |

Table 6.5 Confirmed Operation Environment (Rev.3.70)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 2021-01   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.03.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 8.3.0.202004<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-WI,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
| Endian                             | Little endian/ Big endian   |
| Revision of the module             | Rev.3.70  |
| Board used                         | Renesas Solution Starter Kit for RX23W (product No.: RTK5523Wxxxxxxxxxx)  |

Table 6.6 Confirmed Operation Environment (Rev.3.60)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.8.0   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 8.3.0.201904<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
| Endian                             | Little endian   |
| Revision of the module             | Rev.3.60  |
| Board used                         | Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx)<br>Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565N2CxxxxxBR)<br>Renesas Starter Kit+ for RX65N (product No.: RTK50565NCxxxxxBE)<br>Renesas Starter Kit+ for RX64M (product No.: RTK50564Mxxxxxxxxxx)<br>Renesas Starter Kit+ for RX71M (product No.: RTK50571Mxxxxxxxxxx)<br>Renesas Starter Kit+ for RX113 (product No.: RTK505113xxxxxxxxxx)<br>Renesas Starter Kit+ for RX231 (product No.: RTK505231xxxxxxxxxx)               |

Table 6.7 Confirmed Operation Environment (Rev.3.50)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.7.0<br>IAR Embedded Workbench for Renesas RX 4.12.1   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 8.3.0.201904<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
|                                    | IAR C/C++ Compiler for Renesas RX version 4.12.1<br>Compiler option: The default settings of the integrated development environment.  |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.3.50  |
| Board used                         | Renesas Solution Starter Kit+ for RX23E-A<br>(product No.: RTK0ESXBxxxxxxxxxx)  |

Table 6.8 Confirmed Operation Environment (Rev.3.40)

| Item                               | Contents   |
|------------------------------------|--|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.7.0<br>IAR Embedded Workbench for Renesas RX 4.12.1  |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99<br>GCC for Renesas RX 4.8.4.201902<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module<br>IAR C/C++ Compiler for Renesas RX version 4.12.1<br>Compiler option: The default settings of the integrated development environment. |
| Endian                             | Big endian/little endian   |
| Revision of the module             | Rev.3.40   |
| Board used                         | Renesas Starter Kit+ for RX72N (product No.: RTK5572Nxxxxxxxx)   |

Table 6.9 Confirmed Operation Environment (Rev.3.30)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.7.0<br>IAR Embedded Workbench for Renesas RX 4.12.1   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 4.8.4.201902<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
|                                    | IAR C/C++ Compiler for Renesas RX version 4.12.1<br>Compiler option: The default settings of the integrated development environment.  |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.3.30  |
| Board used                         | RX13T CPU Card (product No.: RTK0EMXA10C00000BJ)  |

Table 6.10 Confirmed Operation Environment (Rev.3.20)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.5.0<br>IAR Embedded Workbench for Renesas RX 4.12.1   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99   |
|                                    | GCC for Renesas RX 4.8.4.201902<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
|                                    | IAR C/C++ Compiler for Renesas RX version 4.12.1<br>Compiler option: The default settings of the integrated development environment.  |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.3.20  |
| Board used                         | Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx)  |

Table 6.11 Confirmed Operation Environment (Rev.3.10)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.5.0   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99 |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.3.10  |
| Board used                         | Renesas Solution Starter Kit for RX23W (product No.: RTK5523Wxxxxxxxxxx)  |

Table 6.12 Confirmed Operation Environment (Rev.3.00)

| Item                               | Contents   |
|------------------------------------|--|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.4.0<br>IAR Embedded Workbench for Renesas RX 4.10.1  |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99<br>GCC for Renesas RX 4.8.4.201803<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-std=gnu99<br>Linker option: The following user defined option should be added to the default settings of the integrated development environment, if "Optimize size (-Os)" is used:<br>-Wl,--no-gc-sections<br>This is to work around a GCC linker issue whereby the linker erroneously discard interrupt functions declared in FIT peripheral module |
| Endian                             | IAR C/C++ Compiler for Renesas RX version 4.10.1<br>Compiler option: The default settings of the integrated development environment.   |
| Endian                             | Big endian/little endian   |
| Revision of the module             | Rev.3.00   |
| Board used                         | Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565Nxxxxxxxxxx)  |

Table 6.13 Confirmed Operation Environment (Rev.2.50)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.3.0   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99 |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.2.50  |
| Board used                         | Renesas Starter Kit for RX72T (product No.: RTK5572Txxxxxxxxxx)   |

Table 6.14 Confirmed Operation Environment (Rev.2.41)

| Item                               | Contents   |
|------------------------------------|--|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.3.0  |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99              |
| Endian                             | Big endian/little endian   |
| Revision of the module             | Rev.2.41   |
| Board used                         | Renesas Starter Kit for RX66T (product No.: RTK50566T0SxxxxxBE)<br>Renesas Starter Kit+ for RX 65N-2MB (product No.: RTK50565N2CxxxxxBR)<br>Renesas Starter Kit+ for RX130-512KB (product No.: RTK5051308CxxxxxBR) |

Table 6.15 Confirmed Operation Environment (Rev.2.40)

| Item                               | Contents   |
|------------------------------------|--|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 7.0.0  |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V3.00.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99              |
| Endian                             | Big endian/little endian   |
| Revision of the module             | Rev.2.40   |
| Board used                         | Renesas Starter Kit for RX66T (product No.: RTK50566T0SxxxxxBE)<br>Renesas Starter Kit+ for RX 65N-2MB (product No.: RTK50565N2CxxxxxBR)<br>Renesas Starter Kit+ for RX130-512KB (product No.: RTK5051308CxxxxxBR) |

Table 6.16 Confirmed Operation Environment (Rev.2.31)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 6.0.0   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V2.07.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99 |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.2.31  |
| Board used                         | Renesas Starter Kit+ for RX 65N-2MB (product No.: RTK50565N2CxxxxxBR)<br>Renesas Starter Kit+ for RX130-512KB (product No.: RTK5051308CxxxxxBR)   |

Table 6.17 Confirmed Operation Environment (Rev.2.30)

| Item                               | Contents  |
|------------------------------------|---|
| Integrated development environment | Renesas Electronics e <sup>2</sup> studio Version 6.0.0   |
| C compiler                         | Renesas Electronics C/C++ Compiler Package for RX Family V2.07.00<br>Compiler option: The following option is added to the default settings of the integrated development environment.<br>-lang = c99 |
| Endian                             | Big endian/little endian  |
| Revision of the module             | Rev.2.30  |
| Board used                         | Renesas Starter Kit+ for RX 65N-2MB (product No.: RTK50565N2CxxxxxBR)<br>Renesas Starter Kit+ for RX130-512KB (product No.: RTK5051308CxxxxxBR)   |

## 6.2 Troubleshooting

(1) Q: I have added the FIT module to the project and built it. Then I got the error: Could not open source file "platform.h".

A: The FIT module may not be added to the project properly. Check if the method for adding FIT modules is correct with the following documents:

- Using CS+:

Application note "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)"

- Using e<sup>2</sup> studio:

Application note "Adding Firmware Integration Technology Modules to Projects (R01AN1723)"

When using a FIT module, the board support package FIT module (BSP module) must also be added to the project. Refer to the application note "Board Support Package Module Using Firmware Integration Technology (R01AN1685)".

(2) Q: I have added the FIT module to the project and built it. Then I got the error: This MCU is not supported by the current r\_mpc\_rx module.

A: The FIT module you added may not support the target device chosen in your project. Check the supported devices of added FIT modules.

(3) Q: I have added the FIT module to the project and built it. Then I got an error for when the configuration setting is wrong.

A: The setting in the file "r\_mpc\_rx\_config.h" may be wrong. Check the file "r\_mpc\_rx\_config.h". If there is a wrong setting, set the correct value for that. Refer to 2.8 Configuration Overview for details.



## 7. Reference Documents

User's Manual: Hardware

The latest version can be downloaded from the Renesas Electronics website.

Technical Update/Technical News

The latest information can be downloaded from the Renesas Electronics website.

User's Manual: Development Tools

RX Family Compiler CC-RX User's Manual (R20UT3248)

The latest versions can be downloaded from the Renesas Electronics website.

## Related Technical Updates

This module reflects the content of the following technical updates.

None

## Revision History

| Rev. | Date         | Description                |  |
|------|--------------|----------------------------|--|
|      |              | Page                       | Summary  |
| 1.00 | Nov15, 2013  | —                          | Initial release.   |
| 1.20 | Apr 17, 2014 | 1,3                        | Added support for the RX64M Group.   |
| 1.30 | Jul 02, 2014 | —                          | Fixed RX63N receive bug.<br>Used latest Colophon.  |
| 1.40 | Dec 12, 2014 | Various<br>1<br>5          | Updated to current app-note template<br>Added RX113 to the list of supported MCUs<br>Added a Code Size section.  |
| 1.50 | Jan 17, 2015 | —                          | Added support for the RX71M Group.   |
| 1.60 | Jun 30, 2015 | —                          | Added support for the RX231 Group.   |
| 1.70 | Sep 30, 2015 | —                          | Added support for the RX23T Group.   |
| 1.80 | Oct 1, 2015  | —                          | Added support for the RX130 Group.   |
| 1.90 | Dec 1, 2015  | —<br>1, 6<br>4<br>11       | Added support for the RX24T Group.<br>Changed the document number for the “Board Support Package Firmware Integration Technology Module” application note.<br>Changed the description in section 2.<br>Added “4. Demo Projects”. |
| 2.00 | Feb 1, 2016  | —<br>12                    | Added support for the RX230 Group.<br>Added “Related Technical Updates”.   |
| 2.01 | Jul 29, 2016 | 11                         | Added RSKRX64M to “4. Demo Projects”.  |
| 2.10 | Oct 1, 2016  | —<br>5                     | Added support for the RX65N Group.<br>Changed 2.9 Code Size for the tabular format of Code Size.<br>Updated 2.9 Code Size for the RX65N Group.   |
| 2.20 | Feb 28, 2017 | —<br>4                     | Added support for the RX24U Group.<br>Added RXC v2.06.00 to “2.5 Supported Toolchains”.  |
| 2.30 | Jul 21, 2017 | —<br>4<br>6                | Added support for the RX130-512KB and RX65N-2MB.<br>Added RXC v2.07.00 to “2.5 Supported Toolchains”.<br>Updated “2.12 Adding the FIT Module to Your Project”.   |
| 2.31 | Oct 31, 2017 | 11<br>12                   | Added RSKRX65N, RSKRX65N-2MB to “4. Demo Projects”<br>Added 4.4 Downloading Demo Project<br>Added 5. Appendices  |
| 2.40 | Sep 28, 2018 | 1<br>5<br>14               | Added support for the RX66T.<br>Added code size corresponding to RX66T<br>6.1 Confirmed Operation Environment:<br>Added table for Rev.2.40   |
| 2.41 | Nov 16, 2018 | —<br>14                    | Added document number in XML<br>Changed Renesas Starter Kit Product No for RX66T.<br>Added table for Rev.2.41  |
| 2.50 | Feb 01, 2019 | Program<br>1<br>8-11<br>14 | Added support for RX72T.<br>Added support for RX72T.<br>Removed ‘Reentrant’ description in each API function.<br>6.1 Confirmed Operation Environment:<br>Added Table for Rev 2.50  |

|      |           |               |  |
|------|-----------|---------------|--|
| 3.00 | May.20.19 | —             | Supported the following compilers:<br>- GCC for Renesas RX<br>- IAR C/C++ Compiler for Renesas RX  |
|      |           | 1             | Added the section of Target compilers.<br>Deleted related documents.   |
|      |           | 4             | 2.2 Software Requirements<br>Requires r_bsp v5.20 or higher  |
|      |           | 5             | Updated the section of 2.8 Code Size   |
|      |           | 14            | Table 6.1 Confirmed Operation Environment:<br>Added table for Rev.3.00   |
|      |           | 18<br>Program | Deleted the section of Website and Support.<br>Changed below for support GCC and IAR compiler:<br>Deleted the inline expansion of the R_MPC_GetVersion function. |
| 3.10 | Jun.28.19 | 1             | Added support for RX23W.   |
|      |           | 14            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.10   |
|      |           | Program       | Added support for RX23W.   |
| 3.20 | Aug.15.19 | 1             | Added support for RX72M.   |
|      |           | 14            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.20<br>Table 6.2: Corrected board name for RX23W  |
|      |           | Program       | Added support for RX72M.   |
| 3.30 | Nov.25.19 | 1             | Added support for RX13T.   |
|      |           | 4             | 2.3 Limitations<br>Added Limitations   |
|      |           | 5             | Updated the section of 2.9 Code Size   |
|      |           | 14            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.30   |
|      |           | Program       | Added support for RX13T.<br>Change the comment of API function to the Doxygen style.   |
| 3.40 | Dec.30.19 | 1             | Added support for RX72N, RX66N.  |
|      |           | 5             | Updated the section of 2.9 Code Size   |
|      |           | 14            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.40   |
|      |           | Program       | Added support for RX72N, RX66N.  |
| 3.50 | Mar.31.20 | 1             | Added support for RX23E-A  |
|      |           | 6             | Updated the section of 2.9 Code Size   |
|      |           | 15            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.50   |
|      |           | Program       | Added support for RX23E-A.   |
| 3.60 | Jun.30.20 | 14            | Updated and added new demo project<br>Added RSKRX72M to "5. Demo Projects".  |
|      |           | 15            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.60   |
|      |           | Program       | Updated and added new demo project   |
| 3.70 | Apr.01.21 | 15            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.70   |
|      |           | Program       | Added support for RX23W-83pin  |
| 3.80 | Apr.01.21 | 15            | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.80   |
|      |           | Program       | Added support for RX72M-100pin, 144pin.  |
| 3.90 | Apr.07.21 | 1             | Added support for RX671  |
|      |           | 4             | Added section 1.3 Using the FIT MPC module.  |

|      |           |         |   |
|------|-----------|---------|---|
|      |           |         | Added sub-section 1.3.1 Using FIT MPC module in C++ project.            |
|      |           | 6       | Added code size corresponding to RX671                                  |
|      |           | 15      | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.3.90        |
|      |           | Program | Added support for RX671   |
| 4.00 | Apr.15.21 | 1       | Added support for RX140   |
|      |           | 6       | Added code size corresponding to RX140                                  |
|      |           | 15      | 6.1 Confirmed Operation Environment:<br>Added Table for Rev.4.00        |
|      |           | Program | Added support for RX140<br>Added CS+ support for demo project           |
| 4.10 | Sep.13.21 | 14      | Added RSKRX671 to "5. Demo Projects".                                   |
|      |           | 15      | Table 6.1: Confirm Operation Environment:<br>Added Table for Rev. 4.10. |
|      |           | Program | Updated and added new demo projects                                     |

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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